

June 2011

# LL4148 Small Signal Diode



COLOR BAND MARKING

1ST BAND 2ND BAND
Black Green

The 1st Band indicates the cathode band

## **Absolute Maximum Ratings \*** T<sub>a</sub> = 25℃ unless otherwise noted

Symbol	Parameter	Value	Units	
$V_{RRM}$	Maximum Repetitive Reverse Voltage	100	V	
I <sub>F(AV)</sub>	Average Rectified Forward Current	200	mA	
i <sub>f</sub>	Recurrent Peak Forward Current	500	mA	
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current Pulse Width = 1.0 second Pulse Width = 1.0 microsecond	1.0 2.0	A A	
T <sub>STG</sub>	Storage Temperature Range	-65 to +200	°C	
T <sub>J</sub>	Operating Junction Temperature Range	-55 to +175	°C	

<sup>\*</sup> These ratings are limiting values above which the serviceability of the diode may be impaired.

### Notes:

- 1) These ratings are based on a maximum junction temperature of 200degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### **Thermal Characteristics**

Symbol	Parameter	Value	Units
P <sub>D</sub>	Power Dissipation	500	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	300	°C/W

Note: Jedec Standard 51-3 method ( PCB Board size 76\*114\*0.6Tmm3 )

## **Electrical Characteristics** $T_a = 25\%$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Units
V <sub>R</sub>	Breakdown Voltage	$I_R = 100 \mu A$	100		V
		$I_R = 5.0 \mu A$	75		V
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 10mA		1.0	V
I <sub>R</sub>	Reverse Leakage	V <sub>R</sub> = 20V		25	nA
		$V_R = 20V, T_A = 150^{\circ}C$		50	μΑ
C <sub>T</sub>	Total Capacitance	$V_R = 0, f = 1.0MHz$		4.0	pF
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 10 \text{mA}, V_R = 6.0 \text{V } (60 \text{mA}),$		4.0	ns
		$I_{rr} = 1.0 \text{mA}, R_L = 100 \Omega$			

### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
Color Band Marking	LL4148	SOD80	7"	8mm	2,500

### **Typical Performance Characteristics**

Figure 1. Reverse Voltage vs Reverse Current BV - 1.0 to 100  $\mu$ A

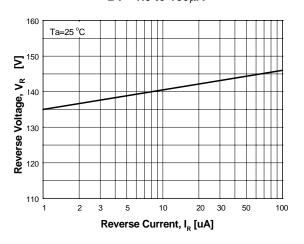


Figure 3. Forward Voltage vs Forward Current  $\mbox{V}_{\mbox{\scriptsize F}}$  - 1 to 100  $\mu\mbox{\scriptsize A}$ 

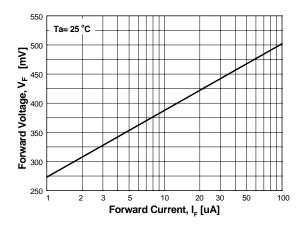


Figure 5. Forward Voltage vs Forward Current  $V_F$  - 10 to 800mA

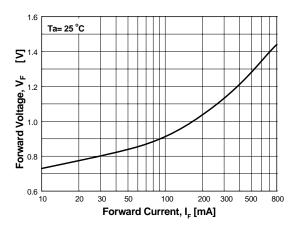


Figure 2. Reverse Voltage vs Reverse Current  $I_R$  - 10 to 100V

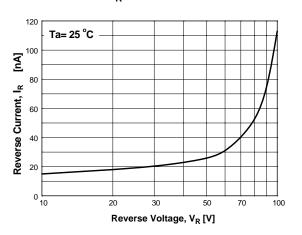


Figure 4. Forward Voltage vs Forward Current  $V_F$  - 0.1 to 10mA

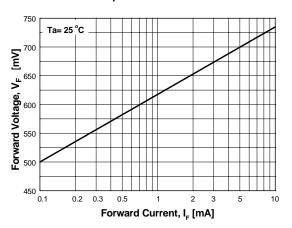
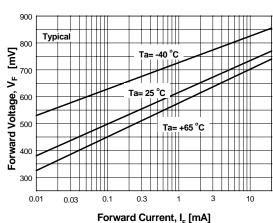


Figure 6. Forward Voltage vs Ambient Temperature V<sub>F</sub> - 0.01 - 20mA (-40 to +65 Deg C)



# **Typical Performance Characteristics** (Continued)

Figure 7. Total Capacitance

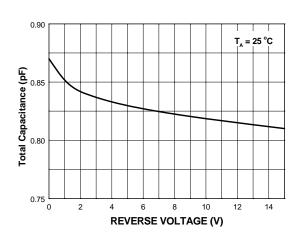


Figure 8. Reverse Recovery Time vs Reverse Recovery Current

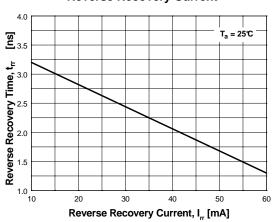


Figure 9. Average Rectified Current ( $I_{F(AV)}$ ) versus Ambient Temperature ( $T_A$ )

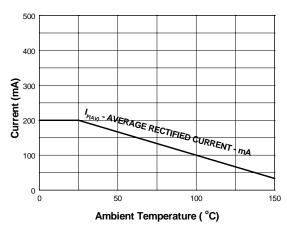
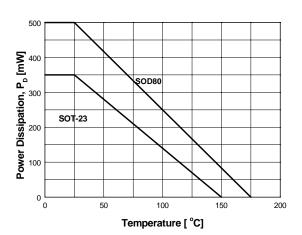
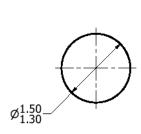


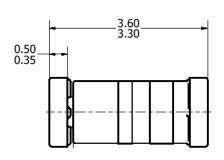
Figure 10. Power Derating Curve



# **Physical Dimensions**

# SOD80





NOTE/s:

- 1) THIS PACKAGE CONFORMS TO JEDEC DO-213D, VARIATION AC, DATED 9/1988. 2) ALL DIMENSIONS ARE IN MILLIMETERS.





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Definition of Terms					
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